PDTA124X series

PNP resistor-equipped transistors; R1 = 22 k Ω , R2 = 47 k Ω

Rev. 08 — 3 September 2009

Product data sheet

1. Product profile

1.1 General description

PNP Resistor-Equipped Transistors (RET) family.

Table 1. Product overview

Type number	Package	NPN complement		
	NXP	XP JEITA JEDEC		
PDTA124XE	SOT416	SC-75	-	PDTC124XE
PDTA124XEF	SOT490	SC-89	-	PDTC124XEF
PDTA124XK	SOT346	SC-59A	TO-236	PDTC124XK
PDTA124XM	SOT883	SC-101	-	PDTC124XM
PDTA124XS[1]	SOT54	SC-43A	TO-92	PDTC124XS
PDTA124XT	SOT23	-	TO-236AB	PDTC124XT
PDTA124XU	SOT323	SC-70	-	PDTC124XU

^[1] Also available in SOT54A and SOT54 variant packages (see Section 2)

1.2 Features

- Built-in bias resistors
- Simplifies circuit design
- 100 mA output current capability
- Reduces component count
- Reduces pick and place costs

1.3 Applications

- Digital applications
- Controlling IC inputs

- Cost-saving alternative for BC857 series in digital applications
- Switching loads

1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CEO}	collector-emitter voltage	open base	-	-	-50	V
I _O	output current (DC)		-	-	-100	mA
R1	bias resistor 1 (input)		15.4	22	28.6	kΩ
R2/R1	bias resistor ratio		1.7	2.1	2.6	

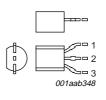


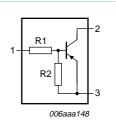
2. Pinning information

Table 3. Pinning

	3		
Pin	Description	Simplified outline	Symbol
SOT54			
1	input (base)		
2	output (collector)		R1 1 2
3	GND (emitter)	1 1 2 2 3 001aab347	1 R2 3
			006aaa148

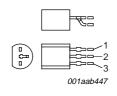
SOT54A	
1	input (base)
2	output (collector)
3	GND (emitter)

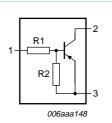




SOT54 variant

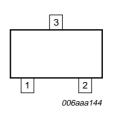
1	input (base)
2	output (collector)
3	GND (emitter)

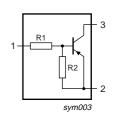




SOT23; SOT323; SOT346; SOT416; SOT490

1	input (base)
2	GND (emitter)
3	output (collector)

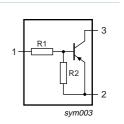




SOT883

1	input (base)
2	GND (emitter)
3	output (collector)





PDTA124X_SER_8

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3. Ordering information

Table 4. Ordering information

Type number	Package					
	Name	Description	Version			
PDTA124XE	SC-75	plastic surface mounted package; 3 leads	SOT416			
PDTA124XEF	SC-89	plastic surface mounted package; 3 leads	SOT490			
PDTA124XK	SC-59A	plastic surface mounted package; 3 leads	SOT346			
PDTA124XM	SC-101	leadless ultra small plastic package; 3 solder lands; body $1.0\times0.6\times0.5~\text{mm}$	SOT883			
PDTA124XS[1]	SC-43A	plastic single-ended leaded (through hole) package; 3 leads	SOT54			
PDTA124XT	-	plastic surface mounted package; 3 leads	SOT23			
PDTA124XU	SC-70	plastic surface mounted package; 3 leads	SOT323			

^[1] Also available in SOT54A and SOT54 variant packages (see Section 2 and Section 9)

4. Marking

Table 5. Marking codes

3	
Type number	Marking code ^[1]
PDTA124XE	31
PDTA124XEF	31
PDTA124XK	44
PDTA124XM	DK
PDTA124XS	TA124X
PDTA124XT	*47
PDTA124XU	*44

^[1] * = -: made in Hong Kong

^{* =} p: made in Hong Kong

^{* =} t: made in Malaysia

^{* =} W: made in China

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CBO}	collector-base voltage	open emitter		-	-50	V
V _{CEO}	collector-emitter voltage	open base		-	-50	V
V_{EBO}	emitter-base voltage	open collector		-	-7	V
VI	input voltage					
	positive			-	+7	V
	negative			-	-40	V
Io	output current (DC)			-	-100	mA
I _{CM}	peak collector current			-	-100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C				
	SOT416		<u>[1]</u>	-	150	mW
	SOT490		[1][2]	-	250	mW
	SOT346		<u>[1]</u>	-	250	mW
	SOT883		[2][3]	-	250	mW
	SOT54		<u>[1]</u>	-	500	mW
	SOT23		<u>[1]</u>	-	250	mW
	SOT323		<u>[1]</u>	-	200	mW
T _{stg}	storage temperature			-65	+150	°C
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-65	+150	°C

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

^[2] Reflow soldering is the only recommended soldering method.

^[3] Device mounted on an FR4 PCB with $60~\mu m$ copper strip line, standard footprint.

6. Thermal characteristics

Table 7. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air				
	SOT416		<u>[1]</u> _	-	833	K/W
	SOT490		[1][2] _	-	500	K/W
	SOT346		<u>[1]</u> _	-	500	K/W
	SOT883		[2][3]	-	500	K/W
	SOT54		<u>[1]</u> -	-	250	K/W
	SOT23		<u>[1]</u> _	-	500	K/W
	SOT323		<u>[1]</u> _	-	625	K/W

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

7. Characteristics

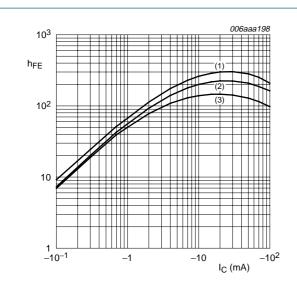
Table 8. Characteristics

T_{amb} = 25 °C unless otherwise specified

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I_{CBO}	collector-base cut-off current	$V_{CB} = -50 \text{ V}; I_E = 0 \text{ A}$	-	-	-100	nA
I_{CEO}	collector-emitter cut-off	$V_{CE} = -30 \text{ V}; I_B = 0 \text{ A}$	-	-	-1	μΑ
	current	$V_{CE} = -30 \text{ V}; I_B = 0 \text{ A};$ $T_j = 150 \text{ °C}$	-	-	-50	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0 \text{ A}$	-	-	-120	μΑ
h _{FE}	DC current gain	$V_{CE} = -5 \text{ V}; I_{C} = -5 \text{ mA}$	80	-	-	
V _{CEsat}	collector-emitter saturation voltage	$I_C = -10 \text{ mA};$ $I_B = -0.5 \text{ mA}$	-	-	-150	mV
$V_{I(off)}$	off-state input voltage	$V_{CE} = -5 \text{ V}; I_{C} = -100 \mu\text{A}$	-	-0.8	-0.5	V
$V_{I(on)}$	on-state input voltage	$V_{CE} = -0.3 \text{ V}; I_{C} = -2 \text{ mA}$	-2	-1.1	-	V
R1	bias resistor 1 (input)		15.4	22	28.6	kΩ
R2/R1	bias resistor ratio		1.7	2.1	2.6	
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz	-	-	3	pF

^[2] Reflow soldering is the only recommended soldering method.

^[3] Device mounted on an FR4 PCB with $60~\mu m$ copper strip line, standard footprint.



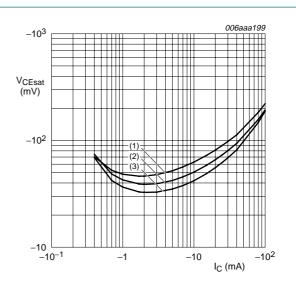
$$V_{CE} = -5 \text{ V}$$

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3) $T_{amb} = -40 \, ^{\circ}C$

Fig 1. DC current gain as a function of collector current; typical values



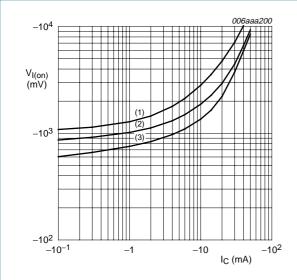
$$I_{\rm C}/I_{\rm B} = 20$$

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -40 \, ^{\circ}C$$

Fig 2. Collector-emitter saturation voltage as a function of collector current; typical values



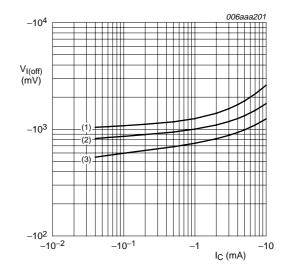
$$V_{CE} = -0.3 \text{ V}$$

(1)
$$T_{amb} = -40 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3) $T_{amb} = 100 \, ^{\circ}C$

Fig 3. On-state input voltage as a function of collector current; typical values



$$V_{CE} = -5 \text{ V}$$

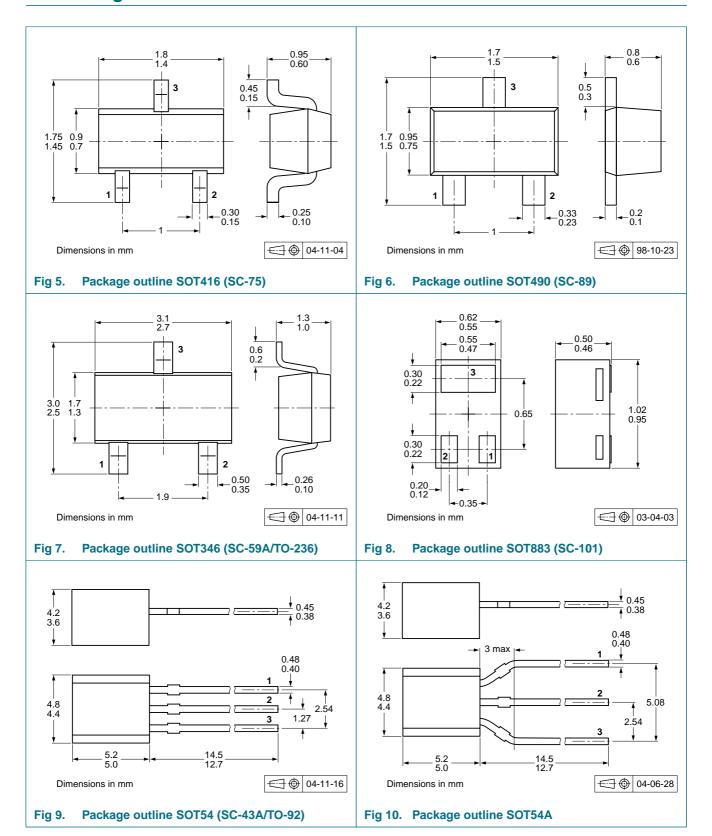
(1)
$$T_{amb} = -40 \, ^{\circ}C$$

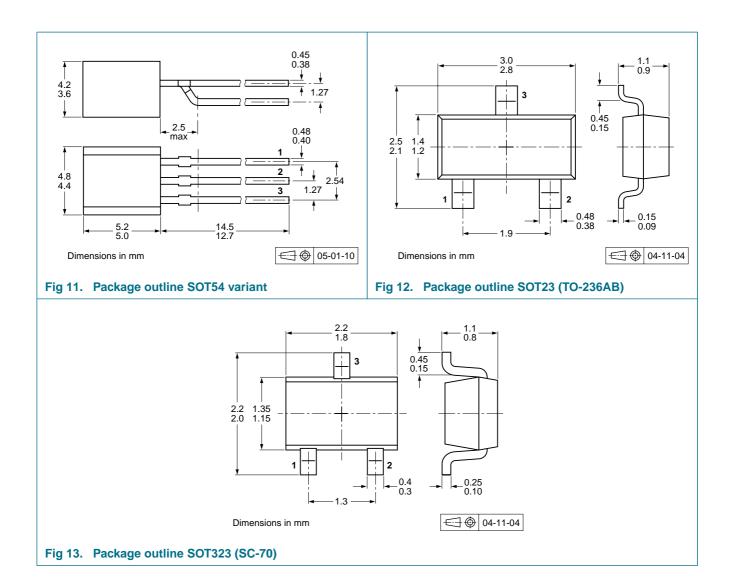
(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3) $T_{amb} = 100 \, ^{\circ}C$

Fig 4. Off-state input voltage as a function of collector current; typical values

8. Package outline





9. Packing information

Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Package	Description	Packing quantity			
		3000	4000	5000	10000
SOT416	4 mm pitch, 8 mm tape and reel	-115	-	-	-135
SOT490	4 mm pitch, 8 mm tape and reel	-	-115	-	-
SOT346	4 mm pitch, 8 mm tape and reel	-115	-	-	-135
SOT883	2 mm pitch, 8 mm tape and reel	-	-	-	-315
SOT54	bulk, straight leads	-	-	-412	-
SOT54A	tape and reel, wide pitch	-	-	-	-116
	tape ammopack, wide pitch	-	-	-	-126
SOT54 variant	bulk, delta pinning	-	-	-112	-
SOT23	4 mm pitch, 8 mm tape and reel	-215	-	-	-235
SOT323	4 mm pitch, 8 mm tape and reel	-115	-	-	-135
	SOT416 SOT490 SOT346 SOT883 SOT54 SOT54A SOT54 variant SOT23	SOT416 4 mm pitch, 8 mm tape and reel SOT490 4 mm pitch, 8 mm tape and reel SOT346 4 mm pitch, 8 mm tape and reel SOT883 2 mm pitch, 8 mm tape and reel SOT54 bulk, straight leads SOT54A tape and reel, wide pitch tape ammopack, wide pitch SOT54 variant bulk, delta pinning SOT23 4 mm pitch, 8 mm tape and reel	3000 SOT416 4 mm pitch, 8 mm tape and reel -115 SOT490 4 mm pitch, 8 mm tape and reel - SOT346 4 mm pitch, 8 mm tape and reel -115 SOT883 2 mm pitch, 8 mm tape and reel - SOT54 bulk, straight leads - SOT54A tape and reel, wide pitch - tape ammopack, wide pitch - SOT54 variant bulk, delta pinning - SOT23 4 mm pitch, 8 mm tape and reel -215	3000 4000 SOT416 4 mm pitch, 8 mm tape and reel -115 - SOT490 4 mm pitch, 8 mm tape and reel - -115 SOT346 4 mm pitch, 8 mm tape and reel -115 - SOT883 2 mm pitch, 8 mm tape and reel - - SOT54 bulk, straight leads - - SOT54A tape and reel, wide pitch - - tape ammopack, wide pitch - - SOT54 variant bulk, delta pinning - - SOT23 4 mm pitch, 8 mm tape and reel -215 -	3000 4000 5000 SOT416 4 mm pitch, 8 mm tape and reel -115 - - SOT490 4 mm pitch, 8 mm tape and reel - -115 - SOT346 4 mm pitch, 8 mm tape and reel -115 - - SOT883 2 mm pitch, 8 mm tape and reel - - - - SOT54 bulk, straight leads - - -412 SOT54A tape and reel, wide pitch - - - tape ammopack, wide pitch - - - - SOT54 variant bulk, delta pinning - - -112 SOT23 4 mm pitch, 8 mm tape and reel -215 - -

^[1] For further information and the availability of packing methods, see <u>Section 12</u>.

10. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PDTA124X_SER_8	20090903	Product data sheet	-	PDTA124X_SER_7
Modifications:		eet was changed to reflect the regal definitions and disclair		
PDTA124X_SER_7	20050811	Product data sheet	-	PDTA124X_SERIES_6
PDTA124X_SERIES_6	20040804	Product specification	-	PDTA124X_SERIES_5
PDTA124X_SERIES_5	20040407	Product specification	-	PDTA124X_SERIES_4
PDTA124X_SERIES_4	20030414	Product specification	-	PDTA124XE_3 PDTA124XEF_2
PDTA124XE_3	19990521	Product specification	-	PDTA124XE_2
PDTA124XE_2	19981125	Product specification	-	PDTA124XE_1
PDTA124XE_1	19971215	Product specification	-	-
PDTA124XEF_2	19990525	Preliminary specification	-	PDTA124XEF_1
PDTA124XEF_1	19981116	Preliminary specification	-	-

11. Legal information

11.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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PDTA124X series

PNP resistor-equipped transistors; R1 = 22 k Ω , R2 = 47 k Ω

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